

## PRODUCT OVERVIEW

The SS8812T provides a dual channel integrated motor drive solution for printers and other motor integration applications. The SS8812T has two H-bridge drives, each providing a maximum output current of 1.6A (at 24V and  $T_a = 25^\circ\text{C}$  with appropriate cooling conditions), which can drive two brush DC motors, or a bipolar stepper motor, or a solenoid or other inductive load. Bipolar stepper motors can be operated in full step, 2 segment, 4 segment, or high segment with software.

The power output module of each H-bridge of the SS8812T is composed of N-type power MOSFETs. Each H-bridge contains a rectifier circuit and a current limiting circuit. Simple parallel digital control interface, attenuation mode can be selected for fast attenuation, slow attenuation and hybrid attenuation.

The SS8812T provides a low-power sleep mode to turn off the internal circuitry to achieve very low static current. This sleep mode is achieved by setting the nSLEEP pin. The internal shut-off function contains overcurrent protection, short circuit protection, undervoltage lock protection and overtemperature protection, and provides a fault output pin nFAULT pin.

The SS8812T is available in an ETSSOP28 package with a bare pad for improved heat dissipation and is lead-free with 100% wuxi plating on the pin frame.

## APPLICATIONS

- POS printer
- Security camera
- Office automation equipment
- Game consoles
- Robots

## FEATURES

- Dual channel H-bridge current control motor driver
  - Single or two brushed DC motors
  - One stepper motor
- PWM control interface
- Current control is optional at fixed frequency
  - 2 bits current control, providing 4 current steps
- Metal oxide semiconductor field effect transistor (MOSFET) with low on-impedance
  - 24V,  $T_a = 25^\circ\text{C}$  to achieve a maximum drive current of 1.6A
  - 24V,  $T_a = 25^\circ\text{C}$   $R_{DS(on)}$  is 720m $\Omega$  (typical value HS + LS)
- 8.2~36V operating voltage range
- Sleep mode Low current
- 3.3V reference voltage built in
- Surface mount package with heat sink
- Protective features
  - Overcurrent Protection (OCP)
  - Thermal shutoff (TSD)
  - Undervoltage Block (UVLO)
  - Fault display Pin (nFAULT)

## PRODUCT INFORMATION

Product model number	Encapsulation form	Remarks
SS8812T-ET-TP	ETSSOP28	Has short-circuit protection self-recovery function

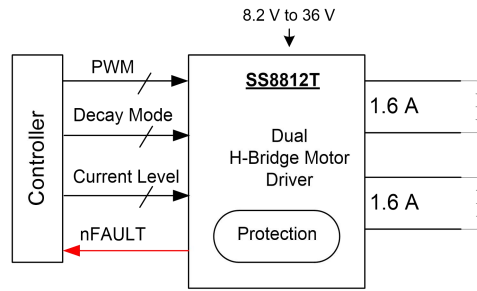
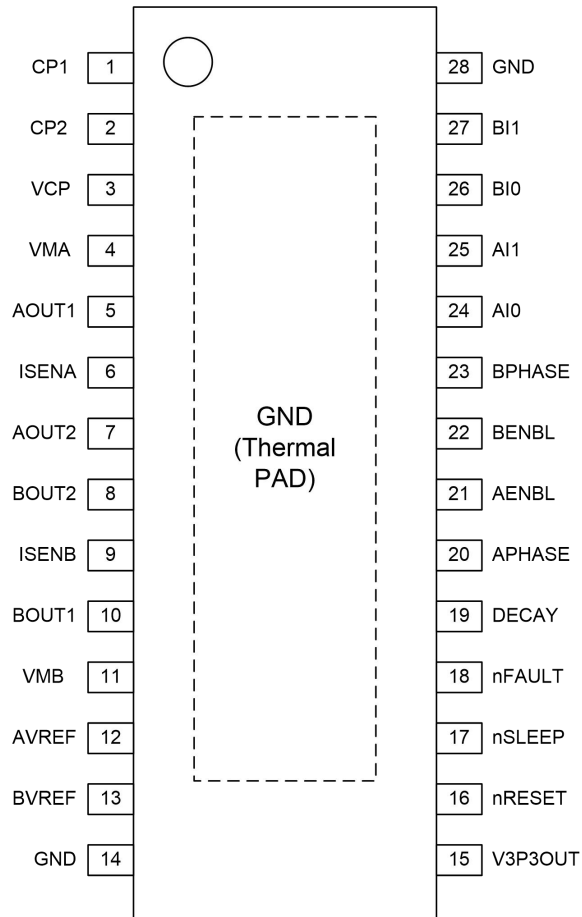


Figure 1. Schematic diagram of typical application

## PIN CONFIGURATION AND FUNCTION



## PIN LIST

Pin names	Pin serial number	Pin description	External component or connection description
<b>Power and ground</b>			
GND	14, 28	chip-wise	All GND pins and chip bare pads are connected to the power source.
PPAD	-	chip-wise	
VMA	4	Channel A H-bridge power supply	Motor power supply, all VMx pins need to be connected together.
VMB	11	B channel H-bridge power supply	
V3P3OUT	15	3.3V rectified output	The external 0.47uF capacitor is connected to the ground for filtering, which can supply power to the reference voltage xVREF.
CP1	1	Charge pump capacitor pin 1	Connect the external 0.01uF / 50V capacitor between CP1 and CP2
CP2	2	Charge pump capacitor pin 2	
VCP	3	High side grid drive	Add 0.1uF capacitor to VM.
<b>Controls</b>			
AENBL	21	Channel A H-bridge Enable input	Input logic high, channel A working.
APHASE	20	Channel A H-bridge direction control input	Input logic high level, AOUT1 output H, AOUT2 output L.
AI0	24	Channel A H-bridge current set input 0	AI1,AI0=0,0→100%, AI1,AI0=0,1→71%, AI1,AI0=1,0→38%, AI1,AI0=1,1→0%
AI1	25	Channel A H-bridge current setup input 1	
BENBL	22	B Channel H-bridge Enable input	Input logic high, channel B working.
BPHASE	23	B Channel H-bridge direction control input	Input logic high level, BOUT1 output H, BOUT2 output L.
BI0	26	B Channel H-bridge current set input 0	BI1,BI0=0,0→100%, BI1,BI0=0,1→71%, BI1,BI0=1,0→38%, BI1,BI0=1,1→0%
BI1	27	B Channel H-bridge current setup input 1	
nSLEEP	17	Sleep mode input	For logic high power, the chip works normally; If the logic level is low, the chip enters the low-power sleep mode
DECAY	19	Attenuation mode select input	Low = Slow attenuation; Hanging = mixed attenuation; High = fast attenuation.
nRESET	16	Reset input	High level, the chip is working; Low level, the chip enters the reset state.
AVREF	12	Channel A H-bridge reference voltage input	Reference voltage input, to set the drive current. An external programmable DAC can be connected for high subdivision or to a fixed reference voltage (e.g. V3P3OUT).
BVREF	13	B channel H-bridge reference voltage input	
<b>Status</b>			

nFAULT	18	Error status Output	Open drain output, if used requires an external pull-up resistor. When overtemperature or overcurrent occurs, the output is low.
<b>Output</b>			
ISENA	6	Channel A H Bridge ground/Isense	Channel A H bridge detects the current end, connect the detection current resistor to the ground, if no current limiting is required, ground directly.
ISENB	9	B Aisle H Bridge ground/Isense	Channel B H bridge detects the current end, connect the detection current resistor to the ground, if there is no need to limit the current, ground directly.
AOUT1	5	Channel A H-bridge output 1	Channel A H-bridge output, define the forward current as AOUT1 → AOUT2
AOUT2	7	Channel A H-bridge output 2	
BOUT1	10	B channel H-bridge output 1	Channel B H-bridge output, define the forward current as BOUT1 → BOUT2
BOUT2	8	B Channel H-bridge output 2	